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Magnetic sensor including electrode disposed on inclined portion whose curvature changes

Abstract

A magnetic sensor includes an MR element and a support member. The support member has an opposed surface including a first inclined portion, and a bottom surface. In a given cross section, the first inclined portion is inclined at a first angle at a first position, and inclined at a second angle smaller than the first angle at a second position. The absolute value of a curvature of the first inclined portion at the first position is less than the absolute value of the curvature of the first inclined portion at the second position. The MR element is provided on the first inclined portion so that the first edge is located above the first position in a given cross section.

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References Cited

U.S. PATENT DOCUMENTS

Patent No.	Issued Date	Patentee Name	U.S. Cl.	CPC
5783284	12/1997	Shinjo et al.	N/A	N/A
7545603	12/2008	Kameda et al.	N/A	N/A
11977136	12/2023	Takahashi	N/A	G01R 33/096
2003/0223158	12/2002	Sasaki	29/603.18	H10N 50/10
2008/0169807	12/2007	Naito et al.	N/A	N/A
2018/0257743	12/2017	Tsuchizawa et al.	N/A	N/A
2022/0229126	12/2021	Takahashi et al.	N/A	N/A

FOREIGN PATENT DOCUMENTS

Patent No.	Application Date	Country	CPC
102021006484	12/2021	DE	N/A
1860450	12/2006	EP	N/A
2000-215413	12/1999	JP	N/A
2005-227134	12/2004	JP	N/A
2006-278440	12/2005	JP	N/A

OTHER PUBLICATIONS

English Translation of the Technical Parts of the Sep. 8, 2022 German Office Action issued in German Patent Application No. 102022101684.6. cited by applicant Translation of Jun. 30, 2025 Office Action issued in Chinese Application No. 202210085333.3. cited by applicant

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Background/Summary

CROSS REFERENCE TO RELATED APPLICATIONS (1) This application is a continuation of U.S. application Ser. No. 18/339,666, filed on Jun. 22, 2023, which is a continuation of U.S. application Ser. No. 17/575,197, filed on Jan. 13, 2022, which claims the benefit of Japanese Priority Patent Application No. 2021-009817, filed on Jan. 25, 2021, the entire contents of each of which are incorporated herein by their reference.

BACKGROUND

- (1) The technology relates to a magnetic sensor including a magnetoresistive element.
- (2) Magnetic sensors using magnetoresistive elements have been used for various applications in recent years. A system including a magnetic sensor may be intended to detect a magnetic field containing a component in a direction perpendicular to the surface of a substrate by using a magnetoresistive element provided on the substrate. In such a case, the magnetic field containing the component in the direction perpendicular to the surface of the substrate can be detected by providing a soft magnetic body for converting a magnetic field in the direction perpendicular to the surface of the substrate into a magnetic field in the direction parallel to the surface of the substrate or locating the magnetoresistive element on an inclined surface formed on the substrate.
- (3) US 2008/0169807 A1 discloses first and second magnetic sensors each including an X-axis sensor, a Y-axis sensor, and a Z-axis sensor disposed on a substrate. The first magnetic sensor has V-shaped grooves in a thick film located on its substrate. Band-like portions of giant magnetoresistive elements constituting the Z-axis sensor are disposed at locations having favorable flatness in the centers of the inclined surfaces of the grooves. The band-like portions are portions constituting the main bodies of the giant magnetoresistive elements and have a long slender band-like planar shape.
- (4) The second magnetic sensor has V-shaped grooves each having a first inclined surface and a second inclined surface in thick films located on its substrate. The second inclined surface constitutes a lower half of the inclined surface of the groove. An angle that the second inclined surface forms with the substrate is greater than an angle that the first inclined surface forms with the substrate. Band-like portions of giant magnetoresistive elements constituting the Z-axis sensor are disposed at locations having favorable flatness in the centers of the second inclined surfaces. The band-like portions have a long slender band-like planar shape.
- (5) US 2008/0169807 A1 describes the fact that the inclined surface is actually formed as a curved surface somewhat bulging out because of the manufacturing process.
- (6) A magnetoresistive element is typically formed by etching a layered film to be the magnetoresistive element by ion milling or reactive ion etching. This etching process uses a photoresist mask. The photoresist mask is formed at a desired position on the layered film by using photolithography. The photoresist mask has a planar shape corresponding to that of the magnetoresistive element. However, the position and dimensions of the photoresist mask can vary due to the precision of the photolithography.
- (7) The effect of variations in the position and dimensions of the photoresist mask appear evidently in forming the magnetoresistive element on a curved surface. To form the magnetoresistive element on a curved surface, the layered film is typically formed in the shape of the curved surface by using a so-called non-conformal film formation apparatus such as a magnetron sputtering apparatus. The thickness (dimension in a direction perpendicular to the curved surface) of the layered film thus decreases as the inclination angle of the curved surface increases.
- (8) Suppose that the curved surface is shaped to bulge out. The amount of change in the inclination angle when the position on the curved surface changes horizontally by a predetermined distance increases with increasing distance from the top of the curved surface. Similarly, the amount of change in the thickness of the layered film increases with increasing distance from the top of the curved surface. If the position or dimensions of the photoresist mask vary to change the position of a wall surface of the photoresist mask on a side opposite from the top of the curved surface, the

thickness of the magnetoresistive element changes greatly near the edge of the magnetoresistive element located on the side opposite from the top of the curved surface. This gives rise to a problem that the desired characteristic is not obtained.

(9) The foregoing problem also arises if the magnetoresistive element is formed on a curved surface of a recessed shape.

SUMMARY

- (10) A magnetic sensor according to one embodiment of the technology includes a magnetoresistive element whose resistance changes with an external magnetic field, and a support member configured to support the magnetoresistive element. The support member has an opposed surface opposed to the magnetoresistive element, and a bottom surface formed of a flat surface located opposite the opposed surface. The opposed surface includes an inclined portion inclined relative to the bottom surface. In a specific cross section of the magnetic sensor perpendicular to the bottom surface, the inclined portion is inclined relative to the bottom surface at a first angle at a first position on the inclined portion, and inclined relative to the bottom surface at a second angle at a second position on the inclined portion, the second angle being smaller than the first angle. (11) An absolute value of a curvature of the inclined portion at the first position is less than an absolute value of a curvature of the inclined portion at the second position. The magnetoresistive element has a first edge and a second edge located at both ends of the magnetoresistive element in a width direction, and is provided on the inclined portion so that the first edge is located above the first position in the cross section.
- (12) In the magnetic sensor according to one embodiment of the technology, the magnetoresistive element may be provided on the inclined portion so that the second edge is located above the second position in the cross section.
- (13) In the magnetic sensor according to one embodiment of the technology, the first position and the second position may fall within a range from a third position on the inclined portion closest to the bottom surface in the cross section to a fourth position on the inclined portion farthest from the bottom surface in the cross section. In such a case, the inclined portion may be inclined relative to the bottom surface so that the first angle is a maximum and the second angle is a minimum within a range from the first position to the second position. The absolute value of the curvature of the inclined portion may be minimized at the first position and maximized at a predetermined position other than the first position within the range from the first position to the second position.
- (14) In the magnetic sensor according to one embodiment of the technology, the opposed surface may include a convex surface protruding in a direction away from the bottom surface. In such a case, the inclined portion may be a part of the convex surface. Alternatively, the opposed surface may include a concave surface recessed toward the bottom surface. In such a case, the inclined portion may be a part of the concave surface.
- (15) In the magnetic sensor according to one embodiment of the technology, the magnetoresistive element may include a magnetic layer having a magnetization whose direction is variable depending on the external magnetic field. The magnetic layer may have a first surface and a second surface located opposite the first surface, and have a thickness that is a dimension in a direction perpendicular to the first surface of the magnetic layer. The thickness at the first edge may be smaller than the thickness at the second edge. The thickness may decrease toward the first edge from the second edge. The first surface and the second surface may each have a shape long in a direction intersecting the cross section.
- (16) In the magnetic sensor according to one embodiment of the technology, the inclined portion of the opposed surface of the support member is inclined relative to the bottom surface at the first angle at the first position, and inclined relative to the bottom surface at the second angle smaller than the first angle at the second position. The absolute value of the curvature of the inclined portion at the first position is less than that of the curvature of the inclined portion at the second position. The magnetoresistive element is provided on the inclined portion so that the first edge is

located above the first position. According to one embodiment of the technology, a change in the thickness of the magnetoresistive element due to variations in the manufacturing process can thereby be reduced.

(17) Other and further objects, features and advantages of the technology will appear more fully from the following description.

Description

BRIEF DESCRIPTION OF THE DRAWINGS

- (1) The accompanying drawings are included to provide a further understanding of the disclosure and are incorporated in and constitute a part of this specification. The drawings illustrate example embodiments and, together with the specification, serve to explain the principles of the technology.
- (2) FIG. **1** is an explanatory diagram showing a schematic configuration of a magnetic sensor system of a first example embodiment of the technology.
- (3) FIG. **2** is a circuit diagram showing the circuit configuration of a magnetic sensor according to the first example embodiment of the technology.
- (4) FIG. **3** is a schematic diagram showing a part of the magnetic sensor according to the first example embodiment of the technology.
- (5) FIG. **4** is a cross-sectional view showing a part of the magnetic sensor according to the first example embodiment of the technology.
- (6) FIG. **5** is a plan view showing a part of the magnetic sensor according to the first example embodiment of the technology.
- (7) FIG. **6** is a cross-sectional view showing a magnetoresistive element of the first example embodiment of the technology.
- (8) FIG. **7** is an explanatory diagram for describing a shape of an inclined portion of the first example embodiment of the technology.
- (9) FIG. **8** is a cross-sectional view showing a step of a manufacturing method for the magnetic sensor according to the first example embodiment of the technology.
- (10) FIG. **9** is a cross-sectional view showing a step that follows the step in FIG. **8**.
- (11) FIG. **10** is a cross-sectional view showing a step that follows the step in FIG. **9**.
- (12) FIG. **11** is a cross-sectional view showing a step that follows the step in FIG. **10**.
- (13) FIG. **12** is a cross-sectional view showing a step that follows the step in FIG. **11**.
- (14) FIG. **13** is a characteristic chart showing the shape and curvature of the opposed surface of the support member according to the first example embodiment of the technology.
- (15) FIG. **14** is an explanatory diagram for describing magnetic charges on a magnetoresistive element of a comparative example.
- (16) FIG. **15** is an explanatory diagram for describing magnetic charges on the magnetoresistive element of the first example embodiment of the technology.
- (17) FIG. **16** is a cross-sectional view showing a modification example of the magnetoresistive element of the first example embodiment of the technology.
- (18) FIG. **17** is a cross-sectional view showing a cross section of a magnetic sensor according to a second example embodiment of the technology.
- (19) FIG. **18** is an explanatory diagram for describing a shape of an inclined portion of the second example embodiment of the technology.

DETAILED DESCRIPTION

- (20) An object of the technology is to provide a magnetic sensor configured so that a change in the thickness of a magnetoresistive element located on an inclined portion due to variations in the manufacturing process can be reduced.
- (21) In the following, some example embodiments and modification examples of the technology

- are described in detail with reference to the accompanying drawings. Note that the following description is directed to illustrative examples of the disclosure and not to be construed as limiting the technology. Factors including, without limitation, numerical values, shapes, materials, components, positions of the components, and how the components are coupled to each other are illustrative only and not to be construed as limiting the technology. Further, elements in the following example embodiments which are not recited in a most-generic independent claim of the disclosure are optional and may be provided on an as-needed basis. The drawings are schematic and are not intended to be drawn to scale. Like elements are denoted with the same reference numerals to avoid redundant descriptions. Note that the description is given in the following order. First Example Embodiment
- (22) Example embodiments of the technology will now be described in detail with reference to the drawings. An outline of a magnetic sensor system including a magnetic sensor according to a first example embodiment of the technology will initially be described with reference to FIG. 1. A magnetic sensor system 100 according to the present example embodiment includes a magnetic sensor 1 according to the present example embodiment and a magnetic field generator 5. The magnetic field generator 5 generates a target magnetic field MF that is a magnetic field for the magnetic sensor 1 to detect (magnetic field to be detected).
- (23) The magnetic field generator **5** is rotatable about a rotation axis C. The magnetic field generator **5** includes a pair of magnets **6**A and **6**B. The magnets **6**A and **6**B are arranged at symmetrical positions with a virtual plane including the rotation axis C at the center. The magnets **6**A and **6**B each have an N pole and an S pole. The magnets **6**A and **6**B are located in an orientation such that the N pole of the magnet **6**A is opposed to the S pole of the magnet **6**B. The magnetic field generator **5** generates the target magnetic field MF in the direction from the N pole of the magnet **6**A to the S pole of the magnet **6**B.
- (24) The magnetic sensor **1** is located at a position where the target magnetic field MF at a predetermined reference position can be detected. The target magnetic field MF at the reference position is part of the magnetic fields generated by the respective magnets **6**A and **6**B. The reference position may be located on the rotation axis C. In the following description, the reference position is located on the rotation axis C. The magnetic sensor **1** detects the target magnetic field MF generated by the magnetic field generator **5**, and generates a detection value Vs. The detection value Vs has a correspondence with a relative position, or rotational position in particular, of the magnetic field generator **5** with respect to the magnetic sensor **1**.
- (25) The magnetic sensor system **100** can be used as a device for detecting the rotational position of a rotatable moving part in an apparatus that includes the moving part. Examples of such an apparatus include a joint of an industrial robot. FIG. **1** shows an example where the magnetic sensor system **100** is applied to an industrial robot **200**.
- (26) The industrial robot **200** shown in FIG. **1** includes a moving part **201** and a support unit **202** that rotatably supports the moving part **201**. The moving part **201** and the support unit **202** are connected at a joint. The moving part **201** rotates about the rotation axis C. For example, if the magnetic sensor system **100** is applied to the joint of the industrial robot **200**, the magnetic sensor **1** may be fixed to the support unit **202**, and the magnets **6**A and **6**B may be fixed to the moving part **201**.
- (27) Now, we define X, Y, and Z directions as shown in FIG. **1**. The X, Y, and Z directions are orthogonal to one another. In the present example embodiment, a direction parallel to the rotation axis C (in FIG. **1**, a direction out of the plane of the drawing) will be referred to as the X direction. In FIG. **1**, the Y direction is shown as a rightward direction, and the Z direction is shown as an upward direction. The opposite directions to the X, Y, and Z directions will be referred to as -X, -Y, and -Z directions, respectively. As used herein, the term "above" refers to positions located forward of a reference position in the Z direction, and "below" refers to positions located on a side of the reference position opposite to "above".

- (28) In the present example embodiment, the direction of the target magnetic field MF at the reference position is expressed as a direction within the YZ plane including the reference position on the rotation axis C. The direction of the target magnetic field MF at the reference position rotates about the reference position within the foregoing YZ plane.
- (29) The magnetic sensor 1 includes magnetoresistive elements (hereinafter, referred to as MR elements) whose resistances change with an external magnetic field. In the present example embodiment, the resistances of the MR elements change with a change in the direction of the target magnetic field MF. The magnetic sensor 1 generates detection signals corresponding to the resistances of the MR elements, and generates a detection value Vs based on the detection signals. (30) Next, a configuration of the magnetic sensor 1 according to the present example embodiment will be described. An example of a circuit configuration of the magnetic sensor 1 will initially be described with reference to FIG. 2. In the example shown in FIG. 2, the magnetic sensor 1 includes four resistor sections 11, 12, 13, and 14, two power supply nodes V1 and V2, two ground nodes G1
- (31) The resistor sections **11** to **14** each include at least one MR element **30**. If each of the resistor sections **11** to **14** includes a plurality of MR elements **30**, the plurality of MR elements **30** in each of the resistor sections **11** to **14** may be connected in series.

and G2, and two signal output nodes E1 and E2.

- (32) The resistor section **11** is provided between the power supply node V**1** and the signal output node E**1**. The resistor section **12** is provided between the signal output node E**1** and the ground node G**1**. The resistor section **13** is provided between the power supply node V**2** and the signal output node E**2**. The resistor section **14** is provided between the signal output node E**2** and the ground node G**2**. The power supply nodes V**1** and V**2** are configured to receive a power supply voltage of predetermined magnitude. The ground nodes G**1** and G**2** are connected to the ground. (33) The potential of the connection point between the resistor section **11** and the resistor section **12** changes depending on the resistance of the at least one MR element **30** of the resistor section **11** and the resistor section **11** and the resistor section **12**. The signal output node E**1** outputs a signal corresponding to the potential of the connection point between the resistor section **11** and the resistor section **12** as a detection signal S**1**.
- (34) The potential of the connection point between the resistor section **13** and the resistor section **14** changes depending on the resistance of the at least one MR element **30** of the resistor section **13** and the resistance of the at least one MR element **30** of the resistor section **14**. The signal output node E**2** outputs a signal corresponding to the potential of the connection point between the resistor section **13** and the resistor section **14** as a detection signal S**2**.
- (35) The magnetic sensor **1** further includes a detection value generation circuit **21** that generates the detection value Vs on the basis of the detection signals S**1** and S**2**. The detection value generation circuit **21** includes an application specific integrated circuit (ASIC) or a microcomputer, for example.
- (36) Next, the configuration of the magnetic sensor **1** will be described in more detail with attention focused on one MR element **30**. FIG. **3** is a schematic diagram showing a part of the magnetic sensor **1**. FIG. **4** is a cross-sectional view showing a part of the magnetic sensor **1**. FIG. **4** shows a cross section parallel to the YZ plane and intersecting the MR element **30**. FIG. **5** is a plan view showing a part of the magnetic sensor **1**.
- (37) The magnetic sensor **1** further includes a support member **60**. The support member **60** supports all the MR elements **30** included in the resistor sections **11** to **14**. As shown in FIGS. **3** and **4**, the support member **60** includes an opposed surface **60***a* opposed, at least in part, to the MR elements **30**, and a bottom surface **60***b* formed of a flat surface located opposite the opposed surface **60***a*. The opposed surface **60***a* is located at an end of the support member **60** in the Z direction. The bottom surface **60***b* is located at an end of the support member **60** in the –Z direction. The bottom surface **60***b* is parallel to the XY plane. For example, the magnetic sensor **1** may be manufactured with the bottom surface **60***b* or a surface corresponding to the bottom surface **60***b* made horizontal.

For example, the magnetic sensor **1** may be installed based on the direction or tilt of the bottom surface **60***b* or the surface corresponding to the bottom surface **60***b*. The bottom surface **60***b* may thus serve as a reference plane in at least either the manufacturing or the installing of the magnetic sensor **1**.

- (38) The opposed surface **60***a* of the support member **60** includes an inclined portion inclined relative to the bottom surface **60***b*. In the present example embodiment, the opposed surface **60***a* includes a flat portion **60***al* parallel to the bottom surface **60***b* and at least one curved portion **60***a***2** not parallel to the bottom surface **60***b*. As shown in FIG. **4**, the curved portion **60***a***2** is a convex surface protruding in a direction away from the bottom surface **60***b*. The foregoing inclined portion is a part of the convex surface. The curved portion **60***a***2** has a curved shape (arch shape) curved to protrude in a direction away from the bottom surface **60***b* (Z direction) in a given cross section parallel to the YZ plane. In a given cross section parallel to the YZ plane, the distance from the bottom surface **60***b* to the curved portion **60***a***2** is maximized at the center of the curved portion **60***a***2** in a direction parallel to the Y direction (hereinafter, referred to simply as the center of the curved portion **60***a***2**).
- (39) The curved portion **60***a***2** extends along the X direction. As shown in FIG. **3**, the overall shape of the curved portion **60***a***2** is a semicylindrical curved surface formed by moving the curved shape (arch shape) shown in FIG. **4** along the X direction.
- (40) The MR element **30** is located on the curved portion **60***a***2**. A portion of the curved portion **60***a***2** from an edge at the end of the curved portion **60***a***2** in the –Y direction to the center of the curved portion **60***a***2** will be referred to as a first inclined portion and be denoted by the symbol SL**1**. A portion of the curved portion **60***a***2** from an edge at the end of the curved portion **60***a***2** in the Y direction to the center of the curved portion **60***a***2** will be referred to as a second inclined portion and be denoted by the symbol SL**2**. In FIG. **3**, the border between the first inclined portion SL**1** and the second inclined portion SL**2** is shown by a dotted line. Both the first and second inclined portions SL**1** and SL**2** are inclined relative to the bottom surface **60***b*. In the present example embodiment, the entire MR element **30** is located on the first inclined portion SL**1** or the second inclined portion SL**2**. FIGS. **3** and **4** show the MR element **30** located on the first inclined portion SL**1**.
- (41) The MR element **30** has a shape that is long in the X direction. As employed herein, the lateral direction of the MR element **30** will be referred to as the width direction of the MR element **30** or simply as the width direction. The MR element **30** may have a planar shape (shape seen in the Z direction), like a rectangle, including a constant width portion having a constant or substantially constant width in the width direction regardless of the position in the X direction. The MR element **30** may have a planar shape including no constant width portion, like an ellipse. Examples of the planar shape of the MR element **30** including a constant width portion include a rectangular shape where both longitudinal ends are straight, an oval shape where both longitudinal ends are semicircular, and a shape where both longitudinal ends are polygonal. FIGS. 3 and 5 show the case where the MR element **30** has a rectangular planar shape. In this example, the MR element **30** has a bottom surface 30a, a top surface 30b, a first edge 30c, a second edge 30d, a third edge 30e, and a fourth edge **30***f*. The bottom surface **30***a* is opposed to the curved portion **60***a***2**. The top surface **30***b* is located opposite the bottom surface 30a. The first and second edges 30c and 30d are located at both ends in the width direction. The third and fourth edges **30***e* and **30***f* are located at both ends in the longitudinal direction. The dimension of the MR element **30** in the width direction is constant or substantially constant regardless of the position in the X direction.
- (42) The support member **60** includes a substrate **61** and an insulating layer **62** located on the substrate **61**. The substrate **61** is a semiconductor substrate made of a semiconductor such as Si, for example. The substrate **61** has a top surface located at an end of the substrate **61** in the Z direction, and a bottom surface located at an end of the substrate **61** in the −Z direction. The bottom surface **60***b* of the support member **60** is constituted by the bottom surface of the substrate **61**. The

- substrate **61** has a constant thickness (dimension in the Z direction).
- (43) The insulating layer **62** is made of an insulating material such as SiO.sub.2, for example. The insulating layer **62** includes a top surface located at an end in the Z direction. The opposed surface **60***a* of the support member **60** is constituted by the top surface of the insulating layer **62**. The insulating layer **62** has a cross-sectional shape such that the curved portion **60***a***2** is formed on the opposed surface **60***a*. Specifically, the insulating layer **62** has a cross-sectional shape of bulging out in the Z direction in a given cross section parallel to the YZ plane.
- (44) The magnetic sensor **1** further includes a lower electrode **41**, an upper electrode **42**, and insulating layers **63**, **64** and **65**. In FIG. **3**, the lower electrode **41**, the upper electrode **42**, and the insulating layers **63** to **65** are omitted. In FIG. **5**, the insulating layers **63** to **65** are omitted. (45) The lower electrode **41** is located on the opposed surface **60***a* of the support member **60** (the top surface of the insulating layer **62**). The insulating layer **63** is located on the opposed surface **60***a* of the support member **60**, around the lower electrode **41**. The MR element **30** is located on the lower electrode **41** and the insulating layer **63**, around the MR element **30**. The upper electrode **42** is located on the MR element **30** and the insulating layer **64**. The insulating layer **65** is located on the insulating layer **64**, around the upper electrode **42**.
- (46) The magnetic sensor **1** further includes a not-shown insulating layer covering the upper electrode **42** and the insulating layer **65**. The lower electrode **41** and the upper electrode **42** are made of a conductive material such as Cu, for example. The insulating layers **63** to **65** and the not-shown insulating layer are made of an insulating material such as SiO.sub.2, for example. (47) The substrate **61** and the portions of the magnetic sensor **1** stacked on the substrate **61** are referred to collectively as a detection unit. FIG. **4** can be said to show the detection unit. The detection value generation circuit **21** shown in FIG. **2** may be integrated with or separate from the detection unit.
- (48) Now, the configuration of the MR element **30** will be described in detail with reference to FIG. **6**. In particular, in the present example embodiment, the MR element **30** is a spin-valve MR element. As shown in FIG. **6**, the MR element **30** includes a magnetization pinned layer **32** having a magnetization whose direction is fixed, a free layer **34** having a magnetization whose direction is variable depending on the direction of an external magnetic field, and a spacer layer **33** located between the magnetization pinned layer **32** and the free layer **34**. The MR element **30** may be a tunneling magnetoresistive (TMR) element or a giant magnetoresistive (GMR) element. In the TMR element, the spacer layer **33** is a tunnel barrier layer. In the GMR element, the spacer layer **33** is a nonmagnetic conductive layer. The resistance of the MR element **30** changes with an angle that the direction of the magnetization of the free layer **34** forms with respect to the direction of the magnetization pinned layer **32**. The resistance is minimized if the angle is 0°. The resistance is maximized if the angle is 180°.
- (49) The magnetization pinned layer **32**, the spacer layer **33**, and the free layer **34** are stacked in this order from the lower electrode **41** in the direction toward the upper electrode **42**. The MR element **30** further includes an underlayer **31** interposed between the magnetization pinned layer **32** and the lower electrode **41**, and a cap layer **35** interposed between the free layer **34** and the upper electrode **42**. The arrangement of the magnetization pinned layer **32**, the spacer layer **33**, and the free layer **34** in the MR element **30** may be vertically reversed from that shown in FIG. **6**. (50) The direction of the magnetization of the magnetization pinned layer **32** is desirably
- orthogonal to the longitudinal direction of the MR element $\bf 30$. In the present example embodiment, the MR element $\bf 30$ is located on the first inclined portion SL $\bf 1$ or the second inclined portion SL $\bf 2$ inclined relative to the bottom surface $\bf 60b$. The direction of the magnetization of the magnetization pinned layer $\bf 32$ is thus also inclined relative to the bottom surface $\bf 60b$.
- (51) For the sake of convenience, in the present example embodiment, the direction of the magnetization of the magnetization pinned layer **32** located on the first inclined portion SL**1** will be

referred to as a U direction or a –U direction. The U direction is a direction rotated from the Y direction toward the Z direction by a predetermined angle. The –U direction is the direction opposite to the U direction. For the sake of convenience, in the present example embodiment, the direction of the magnetization of the magnetization pinned layer **32** located on the second inclined portion SL**2** will be referred to as a V direction or a –V direction. The V direction is a direction rotated from the Y direction toward the –Z direction by a predetermined angle. The –V direction is the direction opposite to the V direction.

- (52) The X, U, and V directions are shown in FIG. **2**. For the sake of convenience, in FIG. **2**, the U direction and the V direction are indicated by the same arrow. In FIG. **2**, the filled arrows indicate the directions of the magnetizations of the magnetization pinned layers **32** of the MR elements **30** included in the respective resistor sections **11** to **14**. The magnetic sensor **1** may be configured so that the directions of the magnetizations of the magnetization pinned layers **32** of the MR elements **30** in the resistor sections **11** and **14** are the U direction, and the directions of the magnetizations of the magnetization pinned layers **32** of the MR elements **30** in the resistor sections **12** and **13** are the –U direction. Alternatively, the magnetization pinned layers **32** of the MR elements **30** in the resistor sections **11** and **14** are the V direction, and the directions of the magnetizations of the magnetization pinned layers **32** of the MR elements **30** in the resistor sections **11** and **13** are the –V direction.
- (53) Alternatively, the magnetic sensor **1** may include a first circuit portion and a second circuit portion each including the resistor sections **11** to **14**. The first circuit portion may be configured so that the directions of the magnetizations of the magnetization pinned layers **32** of the MR elements **30** in the resistor sections **11** and **14** are the U direction, and the directions of the magnetizations of the magnetization pinned layers **32** of the MR elements **30** in the resistor sections **12** and **13** are the –U direction. The second circuit portion may be configured so that the directions of the magnetizations of the magnetization pinned layers **32** of the MR elements **30** in the resistor sections **11** and **14** are the V direction, and the directions of the magnetizations of the magnetization pinned layers **32** of the MR elements **30** in the resistor sections **12** and **13** are the –V direction.
- (54) The free layer **34** corresponds to a magnetic layer according to the technology. The free layer **34** has magnetic shape anisotropy where the direction of the easy axis of magnetization intersects the direction of the magnetization of the magnetization pinned layer **32**. In the present example embodiment, the MR element **30** is patterned to a shape that is long in the X direction. This gives the free layer **34** magnetic shape anisotropy where the direction of the easy axis of magnetization is parallel to the X direction.
- (55) Up to this point, the configuration of the magnetic sensor **1** has been described with attention focused on one MR element **30**. In the present example embodiment, the resistor sections **11** to **14** each include at least one MR element **30**. The magnetic sensor **1** thus includes a plurality of MR elements **30**, a plurality of lower electrodes **41**, and a plurality of upper electrodes **42**. As shown in FIG. **5**, each of the lower electrodes **41** has a long slender shape. The MR element **30** is provided on the top surface of the lower electrode **41**, near one end in the longitudinal direction. Each upper electrode **42** has a long slender shape and is located over two lower electrodes **41** to electrically connect two adjoining MR elements **30**.
- (56) The number of the curved portions **60***a***2** of the opposed surface **60***a* of the support member **60** may be one or more than one. If the number of the curved portions **60***a***2** is one, the plurality of MR elements **30** are located on the one curved portion **60***a***2**. In such a case, the plurality of MR elements **30** may be located on either one of the first and second inclined portions SL**1** and SL**2** or on both the first and second inclined portions SL**1** and SL**2**.
- (57) If the number of curved portions **60***a***2** is more than one, one or a plurality of MR elements **30** may be located on one curved portion **60***a***2**. In such a case, the plurality of curved portions **60***a***2**

- may be arranged along one direction. Alternatively, the plurality of curved portions **60***a***2** may be arranged in a plurality of rows, i.e., more than one curved portion **60***a***2** in both the X and Y directions.
- (58) Next, the inclined portions and the MR elements **30** will be described in more detail with reference to FIGS. **6** and **7**. The following description will be given by using the first inclined portion SL**1** as an example. FIG. **7** is an explanatory diagram for describing the shape of the first inclined portion SL**1**. In FIG. **7**, the underlayer **31** and the cap layer **35** of the MR element **30** are omitted.
- (59) FIG. 7 shows a specific cross section intersecting the MR element **30** and being perpendicular to the bottom surface **60**b of the support member **60**. Such a cross section will hereinafter be denoted by the symbol S. The cross section S intersects the longitudinal direction of the MR element **30**. To describe the shape of the first inclined portion SL**1**, a first position P**1**, a second position P**2**, a third position P**3**, and a fourth position P**4** on the first inclined portion SL**1** in a given cross section S will be defined as follows. The first position P**1** is a position where the first inclined portion SL**1** is inclined relative to the bottom surface **60**b at a first angle **91**. The second position P**2** is a position where the first inclined portion SL**1** is inclined relative to the bottom surface **60**b at a second angle **92** smaller than the first angle **91**. In the present example embodiment, in particular, the first position P**1** is closer to the bottom surface **60**b than is the second position P**2**. In the following description, the angle that a specific surface forms with the bottom surface **60**b will be expressed in terms of an angle of 0° or more and not more than 90°.
- (60) The third position P3 is the position on the first inclined portion SL1 closest to the bottom surface **60***b*. Specifically, the third position P**3** refers to the end of the first inclined portion SL**1** in the -Y direction, and is located at the border between the curved portion **60***a***2** and the flat portion **60***a***1**. The fourth position P**4** is the position on the first inclined portion SL**1** farthest from the bottom surface **60***b*. Specifically, the fourth position P**4** refers to the end of the first inclined portion SL1 in the Y direction, and is located at the border between the first inclined portion SL1 and the second inclined portion SL2, i.e., the center of the curved portion **60***a***2**. The first position P**1** and the second position P2 fall within the range from the third position P3 to the fourth position P4. (61) Both the angle that the first inclined portion SL1 forms with the bottom surface **60***b* at the third position P3 and the angle that the first inclined portion SL1 forms with the bottom surface 60b at the fourth position P4 are 0°. Both the first and second angles θ 1 and θ 2 are greater than 0° and less than 90°. In the present example embodiment, in particular, the first inclined portion SL1 is inclined relative to the bottom surface **60***b* so that the first angle θ **1** is maximum and the second angle θ 2 is minimum within the range from the first position P1 to the second position P2. (62) The outline of the first inclined portion SL1 in a given cross section S includes a plurality of curves where each curve has a different curvature. The absolute value of a curvature k1 of the first inclined portion SL1 at the first position P1 is less than that of a curvature k2 of the first inclined portion SL1 at the second position P2. In other words, the first inclined portion SL1 at the first position P1 is straighter than the first inclined portion SL1 at the second position P2, and curves gently.
- (63) In FIG. **7**, the circular arc denoted by the symbol C**1** represents a part of a circle approximating the first inclined portion SL**1** at the first position P**1**, i.e., a first circle of curvature. The circular arc denoted by the symbol C**2** represents a part of a circle approximating the first inclined portion SL**1** at the second position P**2**, i.e., a second circle of curvature. As shown in FIG. **7**, the first circle of curvature (symbol C**1**) has a radius greater than that of the second circle of curvature (symbol C**2**).
- (64) In the range from the first position P1 to the second position P2, the absolute value of the curvature of the first inclined portion SL1 is maximized at a predetermined position other than the first position P1 on the first inclined portion SL1. The predetermined position may be the second position P2 or a position other than the first and second positions P1 and P2. The absolute value of

- the curvature of the first inclined portion SL1 may increase monotonically from the first position P1 to the second position P2, or may increase on a whole while increasing and decreasing repeatedly.
- (65) In the example shown in FIG. **7**, the outline of the first inclined portion SL**1** in a given cross section S is a smooth curve from the first position P**1** to the second position P**2**. However, the outline of the first inclined portion SL**1** may include a point where the curvature is substantially infinite. In such a case, the outline of the first inclined portion SL**1** bends at the point where the curvature is substantially infinite. An angle θ b that the first inclined portion SL**1** forms with the bottom surface **60***b* at the bending point is defined as follows. An angle that the first inclined portion SL**1** near the bending point and closer to the bottom surface **60***b* than is the bending point will be denoted by θ a. An angle that the first inclined portion SL**1** forms with the bottom surface **60***b* at a point on the first inclined portion SL**1** near the bending point and farther from the bottom surface **60***b* than is the bending point will be denoted by Oc. The angle θ b is an angle smaller than the angle θ a and greater than the angle θ c. The angle θ b may be an average of the angles θ a and θ c.
- (66) The MR element **30** is provided on the first inclined portion SL**1** so that the first edge **30***c* is located above the first position P**1** in a given cross section S. Further, in the present example embodiment, the MR element **30** is provided on the first inclined portion SL**1** so that the second edge **30***d* is located above the second position P**2** in the given cross section S. Thus, in the present example embodiment, the MR element **30** is provided on the area ranging from the first position P**1** to the second position P**2** on the first inclined portion SL**1**.
- (67) As shown in FIGS. **6** and **7**, the free layer **34** of the MR element **30** includes a first surface **34***a*, a second surface **34***b* opposite to the first surface **34***a*, and an outer peripheral surface connecting the first surface **34***a* and the second surface **34***b*. The first surface **34***a* is located farther from the opposed surface **60***a* of the support member **60** than is the second surface **34***b*. The first surface **34***a* is in contact with the cap layer **35**. The second surface **34***b* is in contact with the spacer layer **33**.
- (68) In the present example embodiment, the MR element **30** is patterned to a shape that is long in the X direction. The first and second surfaces **34***a* and **34***b* thus each have a shape that is long in the X direction. The first surface **34***a* has a first edge Ed**1** and a second edge Ed**2** located at both lateral ends of the first surface **34***a*. The first edge Ed**1** is located at the first edge **30***c* of the MR element **30**. The second edge Ed**2** is located at the second edge **30***d* of the MR element **30**.
- (69) As employed herein, an angle that the first surface **34**a forms with the bottom surface **60**b of the support member **60** will be referred to as an inclination angle and denoted by the symbol ϕ . The first surface **34**a is inclined relative to the bottom surface **60**b of the support member **60** so that the inclination angle ϕ is greater than 0°.
- (70) As employed herein, the inclination angle ϕ at the first edge Ed1 will be referred to as an inclination angle ϕ 1. The inclination angle ϕ at the second edge Ed2 will be referred to as an inclination angle ϕ 2. In a given cross section S, the inclination angle ϕ 1 at the first edge Ed1 is greater than the inclination angle ϕ 2 at the second edge Ed2. In a given cross section S, the inclination angle ϕ may increase toward the first edge Ed1 from the second edge Ed2.
- (71) The inclination angle ϕ at a given position on the first surface **34***a* changes depending on the angle θ that the first inclination portion SL**1** forms with the bottom surface **60***b*. Specifically, the inclination angle ϕ at a given position on the first surface **34***a* is substantially the same as the angle θ at a position on the first inclined portion SL**1** below the given position. The inclination angle ϕ thus increases as the angle θ increases.
- (72) The free layer **34** has a thickness T that is a dimension in a direction perpendicular to the first surface **34***a*. The thickness T can also be said to be the distance between the first and second surfaces **34***a* and **34***b* in the direction perpendicular to the first surface **34***a*. As employed herein, the thickness T at the first edge Ed**1** will be referred to as a thickness T**1**. The thickness T at the

- second edge Ed2 will be referred to as a thickness T2. The thickness T1 is also the thickness T at the first edge **30***c* of the MR element **30**. The thickness T2 is also the thickness T at the second edge **30***d* of the MR element **30**. For the sake of convenience, an imaginary surface is assumed by extending the second surface **34***b* along the curved portion **60***a***2**, and the thickness T2 is defined as the distance between the first surface **34***a* and the imaginary surface in the direction perpendicular to the first surface **34***a*.
- (73) In a given cross section S, the thickness T1 at the first edge Ed1 is smaller than the thickness T2 at the second edge Ed2. In a given cross section S, the thickness T may decrease toward the first edge Ed1 from the second edge Ed2.
- (74) The thickness T at a given position on the first surface **34**a changes depending on the angle θ . Specifically, the thickness T at a given position on the first surface **34**a decreases as the angle θ at the position on the first inclined portion SL**1** closest to the given position increases.
- (75) From the relationship between the inclination angle ϕ and the angle θ and the relationship between the thickness T and the angle θ , the thickness T decreases as the inclination angle ϕ increases.
- (76) The foregoing description has been given by using the first inclined portion SL1 as an example. The first inclined portion SL1 and the second inclined portion SL2 have a shape symmetrical or substantially symmetrical about the XZ plane including the center of the curved portion **60***a***2**. The foregoing description of the first inclined portion SL1 therefore also applies to the second inclined portion SL2. The foregoing description of the MR element **30** also applies to the MR element **30** provided on the second inclined portion SL2.
- (77) Now, a manufacturing method for the magnetic sensor **1** according to the present example embodiment will be described with reference to FIG. **8** to FIG. **12**. The manufacturing method for the magnetic sensor **1** includes steps of forming the portions of the magnetic sensor **1** shown in FIGS. **3** to **5**, i.e., the detection unit, and steps of completing the magnetic sensor **1** by using the detection unit. FIGS. **8** to **12** show the steps of forming the detection unit. Note that FIGS. **8** to **12** deal with the MR element **30** formed on the first inclined portion SL**1**.
- (78) As shown in FIG. **8**, in the steps of forming the detection unit, the insulating layer **62** is initially formed on the substrate **61**. The insulating layer **62** may be formed by forming a photoresist mask on the substrate **61** and then forming an insulating film. The insulating layer **62** may be formed by forming an insulating film on the substrate **61** and then etching a part of the insulating film. The formation of the insulating layer **62** completes the support member **60**. (79) FIG. **9** shows the next step. In this step, the lower electrode **41** and the insulating layer **63** are
- formed on the insulating layer **62**, i.e., on the support member **60**. For example, the lower electrode **41** and the insulating layer **63** are formed in the following manner. A metal film is initially formed on the insulating layer **62**. An etching mask is then formed on the metal film. The etching mask may be formed by photolithographically patterning a photoresist layer. Next, the metal film is etched using the etching mask to be made into the lower electrode **41**. The insulating layer **63** is then formed with the etching mask left unremoved. The etching mask is then removed.
- (80) FIG. **10** shows the next step. In this step, films that later become the layers constituting the MR element **30** are formed in order, and a layered film **30**P which later becomes the MR element **30** is formed on the lower electrode **41** and the insulating layer **63**. An etching mask **81** is then formed on the layered film **30**P. The etching mask **81** is formed by photolithographically patterning a photoresist layer. The etching mask **81** has a planar shape (shape seen from above) corresponding to that of the MR element **30**. The etching mask **81** has a first wall surface **81***a* for defining the position of the first edge **30***c* of the MR element **30**, and a second wall surface **81***b* for defining the position of the second edge **30***d* of the MR element **30**.
- (81) FIG. **11** shows the next step. In this step, the layered film **30**P is etched by, for example, ion milling or reactive ion etching using the etching mask **81**. The layered film **30**P is thereby made into the MR element **30**.

- (82) FIG. **12** shows the next step. In this step, the insulating layer **64** is initially formed with the etching mask **81** left unremoved. The etching mask **81** is then removed. The upper electrode **42** and the insulating layer **65** are then formed on the MR element **30** and the insulating layer **64**. The method for forming the upper electrode **42** and the insulating layer **65** is the same as that for forming the lower electrode **41** and the insulating layer **63**.
- (83) A not-shown insulating layer is then formed to cover the upper electrode **42** and the insulating layer **65**. Next, a plurality of terminals constituting the power supply nodes V**1** and V**2** and the like are formed to complete the detection unit of the magnetic sensor **1**.
- (84) Next, an example of the shape and curvature of the opposed surface **60***a* of the support member **60** will be described with reference to FIG. **13**. FIG. **13** is a characteristic chart showing the shape and curvature of the opposed surface **60***a* of the support member **60** in a predetermined cross section S. FIG. **13** is obtained by measuring the opposed surface **60***a* of an actually manufactured support member **60** under an atomic force microscope. In FIG. **13**, the horizontal axis indicates the position in a direction parallel to the Y direction. The vertical axis on the left indicates the curvature of the opposed surface **60***a*. The curvature shown in FIG. **13** is defined so that the curvature has a positive value if the opposed surface **60***a* is a convex surface protruding in a direction away from the bottom surface **60***b*. The vertical axis on the right indicates the height of the opposed surface **60***a*. In FIG. **13**, the height of the opposed surface **60***a* refers to the position in a direction parallel to the Z direction. In FIG. **13**, the height of the flat portion **60***al* of the opposed surface **60***a*. The solid line denoted by the reference numeral **71** represents the curvature of the opposed surface **60***a*. The thick solid line denoted by the reference numeral **72** represents the height of the opposed surface **60***a*.
- (85) In FIG. 13, the points denoted by the symbols P1L and P2L represent the positions corresponding to the first and second edges **30***c* and **30***d* of the MR element **30** provided on the first inclined portion SL1, respectively. The MR element 30 is provided on the area ranging from the point P1L to the point P2L on the first inclined portion SL1. The points P1L and P2L substantially represent the first and second positions P1 and P2 on the first inclined portion SL1. As shown in FIG. **13**, the angle that the opposed surface **60***a* forms with the bottom surface **60***b* at the point P**1**L is greater than the angle that the opposed surface **60***a* forms with the bottom surface **60***b* at the point P**2**L. The absolute value of the curvature of the opposed surface **60***a* at the point P**1**L is less than that of the curvature of the opposed surface **60***a* at the point P**2**L. In the range from the point P1L to the point P2L, the absolute value of the curvature of the opposed surface **60***a* is minimized at the point P1L and maximized at a predetermined position other than the point P1L. (86) Similarly, in FIG. **13**, the points denoted by the symbols P**1**R and P**2**R represent the positions corresponding to the first and second edges **30***c* and **30***d* of an MR element **30** provided on the second inclined portion SL2, respectively. The MR element 30 is provided on the area ranging from the point P1R to the point P2R on the second inclined portion SL2. The points P1R and P2R substantially represent the first and second positions P1 and P2 on the second inclined portion SL2. As shown in FIG. **13**, the angle that the opposed surface **60***a* forms with the bottom surface **60***b* at the point P1R is greater than the angle that the opposed surface **60***a* forms with the bottom surface
- the point P1R to the point P2R, the absolute value of the curvature of the opposed surface 60a is minimized at the point P1R and maximized at a predetermined position other than the point P1R. (87) The operation and effect of the magnetic sensor 1 according to the present example embodiment will now be described. As shown in FIG. 7, in the present example embodiment, the first inclined portion SL1 is inclined relative to the bottom surface 60b at the first angle 01 at the first position P1 and inclined relative to the bottom surface 02 smaller than the first angle 01 at the second position P2 in a given cross section S. The absolute value of the curvature k1 of the first inclined portion SL1 at the first position P1 is less than that of the

60b at the point P**2**R. The absolute value of the curvature of the opposed surface **60**a at the point P**1**R is less than that of the curvature of the opposed surface **60**a at the point P**2**R. In the range from

curvature k2 of the first inclined portion SL1 at the second position P2.

- (88) The MR element **30** provided on the first inclined portion SL**1** is disposed on the first inclined portion SL**1** so that the first edge **30***c* is located above the first position P**1** in a given cross section S. Further, in the present example embodiment, the MR element **30** is disposed on the first inclined portion SL**1** so that the second edge **30***d* is located above the second position P**2** in the given cross section S.
- (89) As described with reference to FIGS. **8** to **12**, the MR element **30** is formed by etching the layered film **30**P. The etching uses the etching mask **81**. The etching mask **81** is formed at a desired position on the layered film **30**P by photolithographically patterning a photoresist layer.
- (90) The etching mask **81** has the first wall surface **81***a* for defining the position of the first edge **30***c* of the MR element **30** and the second wall surface **81***b* for defining the position of the second edge **30***d* of the MR element **30**. The first wall surface **81***a* is designed to be located above the first position P1 defined in advance. The second wall surface **81***b* is designed to be located above the second position P2 defined in advance. However, in the actual manufacturing process, the position and dimensions of the etching mask **81** can vary due to the precision of the photolithography. This changes the positions of the first and second wall surfaces **81***a* and **81***b*, and the positions of the first and second edges **30***c* and **30***d* of the MR element **30** deviate from the respective designed positions.
- (91) The amount of deviation in the angle that the first inclined portion SL1 forms with the bottom surface 60b at a predetermined position P on the first inclined portion SL1 will now be described. Here, the angle that the first inclined portion SL1 forms with the bottom surface 60b at the predetermined position P will be denoted by the symbol θ . The curvature of the first inclined portion SL1 at the predetermined position P will be denoted by the symbol k. The amount of deviation in the angle that the first inclined portion SL1 forms with the bottom surface 60b when the predetermined position P is shifted by Δy in the direction parallel to the Y direction will be denoted by the symbol $\Delta \theta$. If Δy is sufficiently small, the amount of deviation $\Delta \theta$ can be expressed by the following Eq. (1):

(92)
$$\Delta\theta = k * y/\cos$$
 (1)

Here, the curvature k is assumed to be constant.

- (93) As can be seen from Eq. (1), the greater the curvature k, the greater the amount of deviation $\Delta\theta$. The greater the angle θ , the greater the amount of deviation $\Delta\theta$ as well.
- (94) As described above, the thickness T of the free layer **34** of the MR element **30** changes depending on the angle θ . Thus, from Eq. (1), it can be said that the greater the curvature k, the greater the amount of change in the thickness T, and the greater the angle θ , the greater the amount of change in the thickness T.
- (95) In the present example embodiment, the first angle $\theta \mathbf{1}$ is greater than the second angle $\theta \mathbf{2}$. Suppose, for example, that the outline of the first inclined portion SL $\mathbf{1}$ has a constant curvature k like a circular arc, and given the same Δy , the amount of deviation $\Delta \theta$ near the first position P $\mathbf{1}$ is greater than the amount of deviation $\Delta \theta$ near the second position P $\mathbf{2}$. As a result, the amount of change in the thickness T at the first edge $\mathbf{30}c$ is greater than the amount of change in the thickness T at the second edge $\mathbf{30}d$.
- (96) By contrast, in the present example embodiment, the absolute value of the curvature k1 of the first inclined portion SL1 at the first position P1 is less than that of the curvature k2 of the first inclined portion SL1 at the second position P2. In other words, in the present example embodiment, the first inclined portion SL1 is configured to have a relatively small curvature k at the position where the amount of change in the thickness T of the free layer 34 is relatively large. As a result, according to the present example embodiment, a change in the thickness T of the free layer 34 near the first edge 30c due to variations in the manufacturing process can thus be reduced compared to the case where the curvature k of the first inclined portion SL1 is constant or the absolute value of

the curvature **k1** is greater than that of the curvature **k2**.

- (97) According to the present example embodiment, a change in the thicknesses of the layers constituting the MR element **30**, other than the free layer **34** near the first edge **30***c*, due to variations in the manufacturing process can also be reduced. As a result, according to the present example embodiment, a change in the thickness of the MR element **30** (a dimension in the direction perpendicular to the first inclined portion SL**1**) near the first edge **30***c* due to variations in the manufacturing process can be reduced.
- (98) In the present example embodiment, the MR element **30** is provided so that the second edge **30** d is located above the second position P2 where the amount of change in the thickness T of the free layer **34** is relatively small. Therefore, according to the present example embodiment, a change in the thickness T of the free layer **34** near the second edge **30** d and the thickness of the MR element **30** near the second edge **30** d due to variations in the manufacturing process can thus be reduced. As a result, according to the present example embodiment, a change in the thickness T of the entire free layer **34** and the thickness of the entire MR element **30** can be reduced. (99) Next, other effects of the present example embodiment will be described. In the present example embodiment, the thickness T of the free layer **34** at a given position on the first surface **34** d decreases as the angle θ at the position on the first inclined portion SL1 closest to the given position increases. Such a relationship between the thickness T and the angle θ can be achieved by forming the layered film **30**P using a so-called non-conformal film formation apparatus such as a magnetron sputtering apparatus.
- (100) In the present example embodiment, in particular, the thickness T1 at the first edge Ed1 is smaller than the thickness T2 at the second edge Ed2 in a given cross section S. Therefore, according to the present example embodiment, the concentration of magnetic charges at and near the first edge Ed1 of the free layer 34 can thus be reduced.
- (101) The effect of reducing the concentration of magnetic charges will be described in detail below by comparison with an MR element **230** according to a comparative example. The MR element **230** of the comparative example will initially be described with reference to FIG. **14**. FIG. **14** is an explanatory diagram for describing magnetic charges on the MR element **230** of the comparative example. FIG. **14** shows a cross section corresponding to the cross section S. Like the MR element **30** according to the present example embodiment, the MR element **230** according to the comparative example includes a magnetization pinned layer **232**, a spacer layer **233**, a free layer **234**, and a not-shown underlayer and cap layer.
- (102) The MR element **230** of the comparative example is located on a flat surface parallel to the bottom surface **60***b* of the support member **60**. Like the MR element **30** according to the present example embodiment, the MR element **230** is patterned to a shape that is long in the X direction. This gives the free layer **234** magnetic shape anisotropy where the direction of the easy axis of magnetization is parallel to the X direction.
- (103) The free layer **234** includes a first surface **234***a* located at an end in the Z direction, a second surface **234***b* opposite to the first surface **234***a*, and an outer peripheral surface connecting the first surface **234***a* and the second surface **234***b*. Both the first and second surfaces **234***a* and **234***b* are flat surfaces parallel to the bottom surface **60***b*. The first and second surfaces **234***a* and **234***b* each have a shape that is long in the X direction. The first surface **234***a* has a first edge Ed**11** and a second edge Ed**12** located at both ends in the lateral direction of the first surface **234***a*, i.e., a direction parallel to the Y direction. In particular, in the comparative example, the first edge Ed**11** is an edge located at the end of the first surface **234***a* in the –Y direction. The second edge Ed**12** is an edge located at the end of the first surface **234***a* in the Y direction.
- (104) If an external magnetic field is applied to the MR element **230**, the direction of the magnetic moment inside the free layer **234** rotates depending on the direction and strength of the external magnetic field. As a result, the direction of the magnetization of the free layer **234** rotates. Here, magnetic charges occur on the outer peripheral surface of the free layer **234**.

(105) Now, suppose that an external magnetic field in the Y direction is applied to the MR element **230**. If the external magnetic field in the Y direction is applied, positive magnetic charges concentrate at a portion of the outer peripheral surface of the free layer 234 near the second edge Ed**12**, and negative magnetic charges concentrate at a portion of the outer peripheral surface of the free layer **234** near the first edge Ed**11**. In FIG. **14**, the symbols "+" represent positive magnetic charges, and the symbols "-" negative magnetic charges. A demagnetizing field in the -Y direction occurs in the free layer 234 due to such magnetic charges. The strength of the demagnetizing field is higher as it is closer to the magnetic charges. The strength of the demagnetizing field in the portions of the free layer **234** near the first and second edges Ed**11** and Ed**12** is therefore high. The strength of the demagnetizing field in the midsection of the free layer **234** is low. (106) If no external magnetic field is applied, the direction of the magnetization of the free layer **234** and the direction of the magnetic moment in the free layer **234** are parallel to the X direction. If the strength of the external magnetic field is low, the direction of the magnetic moment in the midsection of the free layer **234** starts to rotate toward the Y direction. On the other hand, the direction of the magnetic moment in the portions of the free layer **234** near the first and second edges Ed**11** and Ed**12** does not rotate or hardly rotates. (107) If the strength of the external magnetic field becomes high to a certain extent, the direction of the magnetic moment in the midsection of the free layer **234** becomes the same or substantially the same as the Y direction. Meanwhile, the direction of the magnetic moment in the portions of the free layer **234** near the first and second edges Ed**11** and Ed**12** starts to rotate toward the Y direction. If the strength of the external magnetic field becomes even higher, the direction of the magnetic moment in the portions of the free layer 234 near the first and second edges Ed11 and Ed12 also becomes the same or substantially the same as the Y direction. (108) As described above, in the MR element **230** of the comparative example, the direction of the magnetic moment in the entire free layer 234 does not change uniformly because of the demagnetizing field. As a result, the magnetization of the free layer **234** changes nonlinearly with respect to a change in the strength of the external magnetic field. Consequently, a detection signal generated by a magnetic sensor including the MR element 230 of the comparative example changes nonlinearly with respect to a change in the strength of the external magnetic field. (109) Next, magnetic charges on the MR element 30 according to the present example embodiment will be described. FIG. **15** is an explanatory diagram for describing magnetic charges on the MR element 30. FIG. 15 shows a cross section corresponding to the cross section S. In FIG. 15, the symbols "+" represent positive magnetic charges, and the symbols "-" negative magnetic charges. (110) In the MR element **30** according to the present example embodiment, the thickness T**1** at the first edge Ed1 is smaller than the thickness T2 at the second edge Ed2. Now, suppose that an external magnetic field in the Y direction is applied to the MR element **30**. In such a case, positive magnetic charges concentrate at a portion of the outer peripheral surface of the free layer **34** near the second edge Ed**2** as in the comparative example. By contrast, negative magnetic charges do not concentrate at a portion of the outer peripheral surface of the free layer 34 near the first edge Ed1 but are distributed even over the first surface 34a. This reduces a difference between the strength of the demagnetizing field at the portion of the free layer **34** near the first edge Ed**1** and that of the demagnetizing field in the midsection of the free layer **34**. As the difference decreases, the direction of the magnetic moment at the portion of the free layer **34** near the first edge Ed**1** rotates more similarly to that of the magnetic moment in the midsection of the free layer **34**. According to the present example embodiment, the magnetization of the free layer **34** can thus be prevented from changing nonlinearly with respect to a change in the strength of the external magnetic field. As a result, according to the present example embodiment, the range where the detection signal generated by the magnetic sensor **1** change linearly can be expanded. (111) To reduce variations in the thickness of the MR element **30** due to variations in the manufacturing process, the curvature k of the entire first inclined portion SL1 can be reduced. This,

however, reduces a difference between the first angle $\theta 1$ and the second angle $\theta 2$, and reduces a difference between the thickness T 1 at the first edge Ed 1 and the thickness T 2 at the second edge Ed 2. In particular, if the entire first inclined portion SL 1 has a curvature k of 0, i.e., the entire first inclined portion SL 1 is a flat surface, the first angle $\theta 1$ and the second angle $\theta 2$ are the same, and the thickness T 1 at the first edge Ed 1 and the thickness T 2 at the second edge Ed 2 are the same. This annihilates the effect of reducing the concentration of magnetic charges at and near the first edge Ed 1.

- (112) By contrast, according to the present example embodiment, the absolute value of the curvature $k\mathbf{2}$ of the first inclined portion SL1 at the second position P2 where the angle θ is relatively small is made relatively large. According to the present example embodiment, the difference between the first angle $\theta\mathbf{1}$ and the second angle $\theta\mathbf{2}$ is thereby increased to increase the difference between the thickness T1 at the first edge Ed1 and the thickness T2 at the second edge Ed2. According to the present example embodiment, the concentration of magnetic charges at and near the first edge Ed1 of the free layer 34 can thus be reduced while reducing a change in the thickness T1 at the first edge Ed1 due to variations in the manufacturing process.
- (113) The effects of the present example embodiment have so far been described by using the MR element **30** provided on the first inclined portion SL**1** as an example. However, the foregoing description also applies to the MR element **30** provided on the second inclined portion SL**2** since the first inclined portion SL**1** and the second inclined portion SL**2** have a symmetrical shape. Modification Example
- (114) Next, a modification example of the MR element **30** will be described with reference to FIG. **16**. In the modification example, the MR element **30** is an anisotropic magnetoresistive (AMR) element. In the modification example, the MR element 30 includes a magnetic layer 36 given magnetic anisotropy, instead of the magnetization pinned layer 32, the spacer layer 33, and the free layer **34** shown in FIG. **6**. The magnetic layer **36** has a magnetization whose direction is variable depending on the direction of the external magnetic field. As described above, the MR element **30** is patterned to a shape that is long in the X direction. This gives the magnetic layer **36** magnetic shape anisotropy where the direction of the easy axis of magnetization is parallel to the X direction. (115) The magnetic layer **36** has a first surface **36***a* having a shape that is long in the X direction, a second surface **36***b* opposite to the first surface **36***a*, and an outer peripheral surface connecting the first surface **36***a* and the second surface **36***b*. The description of the shape of the MR element **30** with reference to FIGS. 6 and 7 also applies to the modification example. The description of the shape of the MR element **30** applies to the shape of that in the modification example, with the free layer **34**, the first surface **34***a*, and the second surface **34***b* in the description replaced with the magnetic layer **36**, the first surface **36***a*, and the second surface **36***b*, respectively. Second Example Embodiment
- (116) A second example embodiment of the technology will now be described. Initially, a configuration of a magnetic sensor according to the present example embodiment will be described with reference to FIG. 17. FIG. 17 is a cross-sectional view showing a part of the magnetic sensor according to the present example embodiment.
- (117) A configuration of the magnetic sensor **101** according to the present example embodiment differs from that of the magnetic sensor **1** according to the first example embodiment in the following respect. The magnetic sensor **101** according to the present example embodiment includes MR elements **130** instead of the MR elements **30** according to the first example embodiment. FIG. **17** shows a cross section parallel to the YZ plane and intersecting an MR element **130**.
- (118) The opposed surface **60***a* of the support member **60** includes at least one curved portion **60***a***3** not parallel to the bottom surface **60***b*, instead of the curved portion **60***a***2** according to the first example embodiment. As shown in FIG. **17**, the curved portion **60***a***3** is a concave surface recessed toward the bottom surface **60***b*. As will be described below, the opposed surface **60***a* includes inclined portions that are a part of the concave surface (curved portion **60***a***3**). The curved portion

- **60***a***3** has a curved shape (arch shape) curved to be recessed toward the bottom surface **60***b* (-Z direction) in a given cross section parallel to the YZ plane. In the given cross section parallel to the YZ plane, the distance from the bottom surface **60***b* to the curved portion **60***a***3** is the smallest at the center of the curved portion **60***a***3** in a direction parallel to the Y direction (hereinafter, referred to simply as the center of the curved portion **60***a***3**).
- (119) The curved portion **60***a***3** extends along the X direction. The overall shape of the curved portion **60***a***3** is a semicylindrical curved surface formed by moving the curved shape shown in FIG. **17** along the X direction. The insulating layer **62** of the support member **60** has a cross-sectional shape such that the curved portion **60***a***3** is formed in the opposed surface **60***a*. Specifically, the insulating layer **62** has a cross-sectional shape recessed in the –Z direction in a given cross section parallel to the YZ plane.
- (120) A portion of the curved portion **60***a***3** from an edge at the end of the curved portion **60***a***3** in the Y direction to the center of the curved portion **60***a***3** will be referred to as a first inclined portion and be denoted by the symbol SL**11**. A portion of the curved portion **60***a***3** from an edge at the end of the curved portion **60***a***3** in the –Y direction to the center of the curved portion **60***a***3** will be referred to as a second inclined portion and be denoted by the symbol SL**12**. Both the first and second inclined portions SL**11** and SL**12** are inclined relative to the bottom surface **60***b*. In the present example embodiment, the entire MR element **130** is located on the first inclined portion SL**11** or the second inclined portion SL**12**. FIG. **17** shows how the MR element **130** is located on the first inclined portion SL**11**.
- (121) The MR element **130** has a shape that is long in the X direction. The MR element **130** has a rectangular planar shape. As employed herein, the lateral direction of the MR element **130** will be referred to as the width direction of the MR element **130** or simply as the width direction. The MR element **130** has a bottom surface **130***a*, a top surface **130***b*, a first edge **130***c*, a second edge **130***d*, a third edge, and a fourth edge. The bottom surface **130***a* is opposed to the curved portion **60***a***3**. The top surface **130***b* is located opposite the bottom surface **130***a*. The first and second edges **130***c* and **130***d* are located at both ends in the width direction. The third and fourth edges are located at both ends in the longitudinal direction. The dimension of the MR element **130** in the width direction is constant or substantially constant regardless of the position in the X direction. (122) The MR element **130** may be a spin-valve MR element or an AMR element. The following description will be given by using the case where the MR element **130** is a spin-valve MR element as an example. Like the MR element **30** shown in FIG. **6** of the first example embodiment, the MR element **130** includes an underlayer **31**, a magnetization pinned layer **32**, a spacer layer **33**, a free layer **34**, and a cap layer **35**. The free layer **34** has magnetic shape anisotropy where the direction of the easy axis of magnetization is parallel to the X direction.
- (123) Next, the inclined portions and the MR elements **130** will be described in detail with reference to FIG. **18**. The following description will be given by using the first inclined portion SL**11** as an example. FIG. **18** is an explanatory diagram for describing the shape of the first inclined portion SL**11**. FIG. **18** is an enlarged view of a part of the cross section shown in FIG. **17**. In FIG. **18**, the underlayer **31** and the cap layer **35** of the MR element **130** are omitted. (124) A cross section intersecting the MR element **130** and being perpendicular to the bottom surface **60***b* of the support member **60** will be denoted by the symbol S. To describe the shape of the first inclined portion SL**11**, a first position P**11**, a second position P**12**, a third position P**13**, and a fourth position P**14** on the first inclined portion SL**11** in a given cross section S will be defined as follows. The first position P**11** is a position where the first inclined portion SL**11** is inclined relative to the bottom surface **60***b* at a first angle **911**. The second position P**12** is a position where the first inclined portion SL**11** is inclined relative to the bottom surface **60***b* at a second angle **912** smaller
- (125) The third position P13 is the position on the first inclined portion SL11 closest to the bottom

than the first angle θ **11**. In the present example embodiment, in particular, the first position P**11** is

farther from the bottom surface **60***b* than is the second position P**12**.

- surface **60***b*. Specifically, the third position P**13** is located at the border between the first inclined portion SL**11** and the second inclined portion SL**12**, i.e., the center of the curved portion **60***a***3**. The fourth position P**14** is the position on the first inclined portion SL**11** farthest from the bottom surface **60***b*. Specifically, the fourth position P**14** is located at the border between the curved portion **60***a***3** and the flat portion **60***a***1**. The first position P**11** and the second position P**12** fall within the range from the third position P**13** to the fourth position P**14**.
- (126) Both the angle that the first inclined portion SL**11** forms with the bottom surface **60**b at the third position P**13** and the angle that the first inclined portion SL**11** forms with the bottom surface **60**b at the fourth position P**14** are 0°. Both the first and second angles θ **11** and **012** are greater than 0° and less than 90°.
- (127) The outline of the first inclined portion SL11 in a given cross section S includes a plurality of curves where each curve has a different curvature. The absolute value of a curvature k11 of the first inclined portion SL11 at the first position P11 is less than that of a curvature k12 of the first inclined portion SL11 at the second position P12.
- (128) In FIG. **18**, the circular arc denoted by the symbol C**11** represents a part of a circle approximating the first inclined portion SL**11** at the first position P**11**, i.e., a first circle of curvature. The circular arc denoted by the symbol C**12** represents a part of a circle approximating the first inclined portion SL**11** at the second position P**12**, i.e., a second circle of curvature. As shown in FIG. **18**, the first circle of curvature (symbol C**11**) has a radius greater than that of the second circle of curvature (symbol C**12**).
- (129) The MR element **130** is provided on the first inclined portion SL**11** so that the first edge **130***c* is located above the first position P**11** in a given cross section S. Further, in the present example embodiment, the MR element **130** is provided on the first inclined portion SL**11** so that the second edge **130***d* is located above the second position P**12** in the given cross section S.
- (130) As described in the first example embodiment, the free layer **34** has a first surface **34***a*, a second surface **34***b*, and an outer peripheral surface. The first surface **34***a* has a first edge Ed**1** and a second edge Ed**2** located at both lateral ends of the first surface **34***a*. The first edge Ed**1** is located at the first edge **130***c* of the MR element **130**. The second edge Ed**2** is located at the second edge **130***d* of the MR element **130**.
- (131) The relationship between the inclination angle $\phi 1$ at the first edge Ed1 and the inclination angle $\phi 2$ at the second edge Ed2 in a given cross section S is the same as in the first example embodiment. The relationship between the thickness T1 at the first edge Ed1 and the thickness T2 at the second edge Ed2 in a given cross section S is also the same as in the first example embodiment. For the sake of convenience, an imaginary surface is assumed by extending the second surface 34b along the curved portion 60a3, and the thickness T1 is defined as the distance between the first surface 34a and the imaginary surface in the direction perpendicular to the first surface 34a.
- (132) The foregoing description has been given by using the first inclined portion SL11 as an example. The first inclined portion SL11 and the second inclined portion SL12 have a shape symmetrical or substantially symmetrical about the XZ plane including the center of the curved portion 60a3. The foregoing description of the first inclined portion SL11 therefore also applies to the second inclined portion SL12. The foregoing description of the MR element 130 also applies to the MR element 130 provided on the second inclined portion SL12.
- (133) The configuration, operation and effects of the present example embodiment are otherwise the same as those of the first example embodiment.
- (134) The technology is not limited to the foregoing example embodiments, and various modification examples may be made thereto. For example, the number and arrangement of MR elements and the number and arrangement of curved portions are not limited to those described in the example embodiments, and may be freely chosen as long as the requirements set forth in the claims are satisfied.

- (135) The first and second surfaces **34***a* and **34***b* of the free layer **34** according to the technology may each have a shape long in a direction intersecting a given cross section S, not necessarily in the direction parallel to the X direction.
- (136) The second edge of the MR element according to the technology may be located on the flat portion **60***a***1** or a part of the curved portion parallel to the bottom surface **60***b*.
- (137) Obviously, various modification examples and variations of the technology are possible in the light of the above teachings. Thus, it is to be understood that, within the scope of the appended claims and equivalents thereof, the technology may be practiced in other embodiments than the foregoing example embodiments.

Claims

- 1. A magnetic sensor comprising: a magnetoresistive element; an electrode made of a conductive material and connected to the magnetoresistive element; and a support member, wherein: the support member has an opposed surface, and a bottom surface formed of a flat surface located opposite the opposed surface; the opposed surface includes an inclined portion inclined relative to the bottom surface; in a specific cross section of the magnetic sensor perpendicular to the bottom surface, the inclined portion is inclined relative to the bottom surface at a first angle at a first position on the inclined portion, and inclined relative to the bottom surface at a second angle at a second position on the inclined portion, the second angle being smaller than the first angle; an absolute value of a curvature of the inclined portion at the first position is less than an absolute value of a curvature of the inclined portion at the second position; and the electrode is provided on the inclined portion.
- 2. The magnetic sensor according to claim 1, wherein the first position and the second position fall within a range from a third position on the inclined portion closest to the bottom surface in the cross section to a fourth position on the inclined portion farthest from the bottom surface in the cross section.
- 3. The magnetic sensor according to claim 2, wherein: the inclined portion is inclined relative to the bottom surface so that the first angle is a maximum and the second angle is a minimum within a range from the first position to the second position; and the absolute value of the curvature of the inclined portion is minimized at the first position and maximized at a predetermined position other than the first position within the range from the first position to the second position.
- 4. The magnetic sensor according to claim 1, wherein: the opposed surface includes a convex surface protruding in a direction away from the bottom surface; and the inclined portion is a part of the convex surface.
- 5. The magnetic sensor according to claim 1, wherein: the opposed surface includes a concave surface recessed toward the bottom surface; and the inclined portion is a part of the concave surface.
- 6. The magnetic sensor according to claim 1, wherein the magnetoresistive element is provided on the electrode.
- 7. The magnetic sensor according to claim 6, wherein: the magnetoresistive element has a first edge and a second edge located at both ends of the magnetoresistive element in a width direction, and includes a magnetic layer having a magnetization whose direction is variable depending on an external magnetic field; the magnetic layer has a first surface and a second surface located opposite the first surface, and has a thickness that is a dimension in a direction perpendicular to the first surface of the magnetic layer; and the thickness at the first edge is smaller than the thickness at the second edge.
- 8. The magnetic sensor according to claim 7, wherein the thickness decreases toward the first edge from the second edge.

	in a direction in					